

DECLARATION OF SOLE INVENTOR FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: **Microelectronic Device Fabricating Method, Method Of Forming A Pair Of Conductive Device Components Of Different Base Widths From A Common Deposited Conductive Layer, And Integrated Circuitry**, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56.

**PRIOR FOREIGN APPLICATIONS:**

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under

1 Section 1001 of Title 18 of the United States Code and that such willful  
2 false statement may jeopardize the validity of the application or any  
3 patent issued therefrom.

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5 Full name of sole inventor: Alan R. Reinberg

6 Inventor's Signature: Alan R. Reinberg

7 Date: May 16, 2000

8 Residence: Westport, Connecticut

9 Citizenship: U.S.A.

10 Post Office Address: 6 Terhune Drive  
11 Westport, CT 06880  
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